

/ Part Number

USB-M05-003

## Materials and Finish

Housing: Shell: Contacts:

Specifications

Current Rating:

Voltage Rating: Withstanding Voltage:

**Contact Resistance:** 

Insulation Resistance:

PA 6T, glass filled (UL94V-0) Copper Alloy, Tin over Cu Copper Alloy Contact Plating: Solder area - Tin over Ni Mating area - 30µ" Au over Ni

### Features

According to Hi-Speed USB standard, data transmission rate up to 480 Mbit / sec

 $100M\Omega$  at 100 V DC for 1 minute

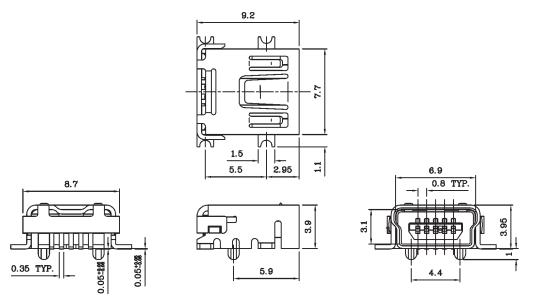
50mΩ max. at20mV max. / 100mA max.

1A max. per contact

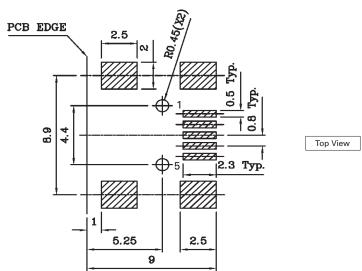
500V AC for 1 minute

100V ACrms max.

### 山 **Outline Dimensions SMT Type**



#### 山 **Recommended PCB Layout**





# I/O Connectors

Series USB-M Mini USB - Plug (5 Pin Solder Port )

## **Specifications**

Insulation Resistance: Withstanding Voltage: Voltage Rating: Current Rating: Contact Resistance: 100M $\Omega$  at 100 V DC for 1 minute 100V AC for 1 minute 30V ACrms max. 1A max. per contact 30m $\Omega$  max. at20mV max. / 100mA max.

## Part Number

## USB-M05-P

**Note:** USB-M05-P is only available in assembled versions with moulded strain relief. For more details please contact Yamaichi.

## Materials and Finish

Shell:Ni plated over CopperHousing:Thermoplastic, glass filled (UL94V-0)Contacts:Copper AlloyContact Plating:Mating area - 30µ" Au over Nickel

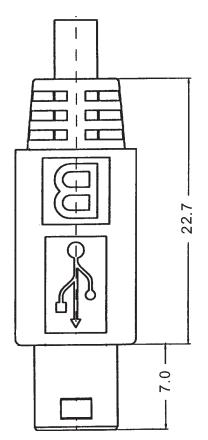


Photo showing plug without plastic molding

## Features

- Premating contacts to secure data protection when hot plug / unplug
- According to Hi-Speed USB standard, data transmission rate up to 480 Mbit / sec

## Outline Dimensions Plug



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